

**P-Channel Enhancement-Mode  
Vertical DMOS FETs****Ordering Information**

$BV_{DSS}$ / $BV_{DGS}$	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)	Order Number / Package
			TO-92
-30V	2.5Ω	-1.5A	VP0300L

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**Features**

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low  $C_{iss}$  and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-channel devices

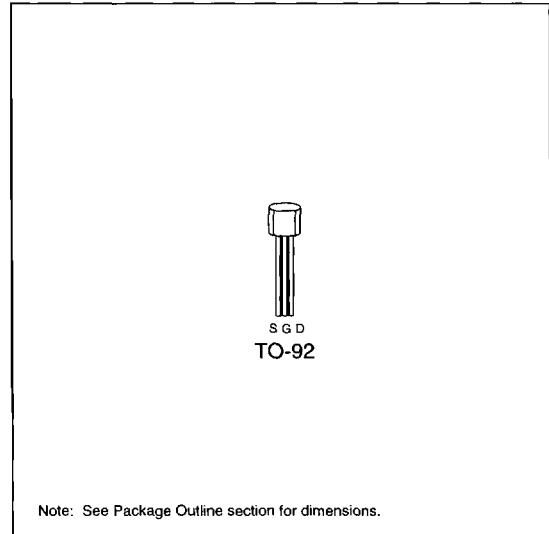
**Advanced DMOS Technology**

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

**Applications**

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

**Package Options****Absolute Maximum Ratings**

Drain-to-Source Voltage	$BV_{DSS}$
Drain-to-Gate Voltage	$BV_{PGS}$
Gate-to-Source Voltage	$\pm 20V$
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

\* Distance of 1.6 mm from case for 10 seconds.

## Thermal Characteristics

Package	$I_D$ (continuous)*	$I_D$ (pulsed)	Power Dissipation $T_c = 25^\circ\text{C}$	$\theta_{ja}$ °C/W	$\theta_{jc}$ °C/W
TO-92	-0.32A	-0.87A	1.0W	170	125

\*  $I_D$  (continuous) is limited by max rated  $T_j$ .

## Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	-30			V	$V_{GS} = 0V, I_D = -10\mu\text{A}$
$V_{GS(\text{th})}$	Gate Threshold Voltage	-1.0	-1.8	-4.5	V	$V_{GS} = V_{DS}, I_D = -1\text{mA}$
$I_{GSS}$	Gate Body Leakage			-100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$
$I_{DSS}$	Zero Gate Voltage Drain Current			-10	$\mu\text{A}$	$V_{GS} = 0V, V_{DS} = -25V$
				-500	$\mu\text{A}$	$V_{GS} = 0V, V_{DS} = -25V, T_A = 125^\circ\text{C}$
$I_{D(\text{ON})}$	ON-State Drain Current	-1.5	-1.7		A	$V_{GS} = -12V, V_{DS} = -10V$
$R_{DS(\text{ON})}$	Static Drain-to-Source ON-State Resistance			2.5	$\Omega$	$V_{GS} = -12V, I_D = -1\text{A}$
$G_{FS}$	Forward Transconductance	200			$\text{m}\Omega$	$V_{DS} = -10V, I_D = -0.5\text{A}$
$C_{ISS}$	Input Capacitance			150		$V_{GS} = 0V, V_{DS} = -15V$ $f = 1\text{MHz}$
$C_{OSS}$	Common Source Output Capacitance			120	pF	
$C_{RSS}$	Reverse Transfer Capacitance			60	pF	
$t_{(\text{ON})}$	Turn-ON Time			30	ns	$V_{DD} = -25V, I_D = -1\text{A}$ $R_{\text{GEN}} = 25\Omega$
$t_{(\text{OFF})}$	Turn-OFF Time			30	ns	
$V_{SD}$	Diode Forward Voltage Drop			-1.2	V	$V_{GS} = 0V, I_{SD} = -1.5\text{A}$

### Notes

- All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

## Switching Waveforms and Test Circuit

